4AK26

Silicon N-Channel Power MOS FET Array

HITACHI

Application

High speed power switching

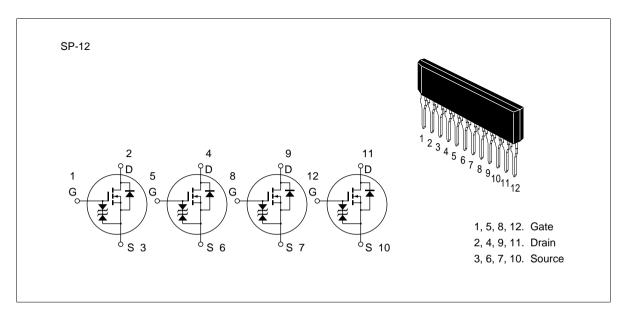
Features

Low on-resistance

$$R_{DS(on)} \le 0.06$$
 , $V_{GS} = 10 \text{ V}$, $I_D = 5 \text{ A}$
 $R_{DS(on)} \le 0.075$, $V_{GS} = 4 \text{ V}$, $I_D = 5 \text{ A}$

- Capable of 4 V gate drive
- Low drive current
- High speed switching
- High density mounting
- Suitable for motor driver and solenoid driver and lamp driver

Outline





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Absolute Maximum Ratings ($Ta = 25^{\circ}C$)

Item	Symbol	Ratings	Unit
Drain to source voltage	$V_{\scriptscriptstyle DSS}$	60	V
Gate to source voltage	$V_{\sf GSS}$	±20	V
Drain current	I _D	10	A
Drain peak current	l _{D(pulse)} *1	32	A
Body to drain diode reverse drain current	I _{DR}	10	A
Channel dissipation	Pch (Tc = 25°C)*2	28	W
Channel dissipation	Pch*2	4	W
Channel temperature	Tch	150	°C
Storage temperature	Tstg	-55 to +150	°C

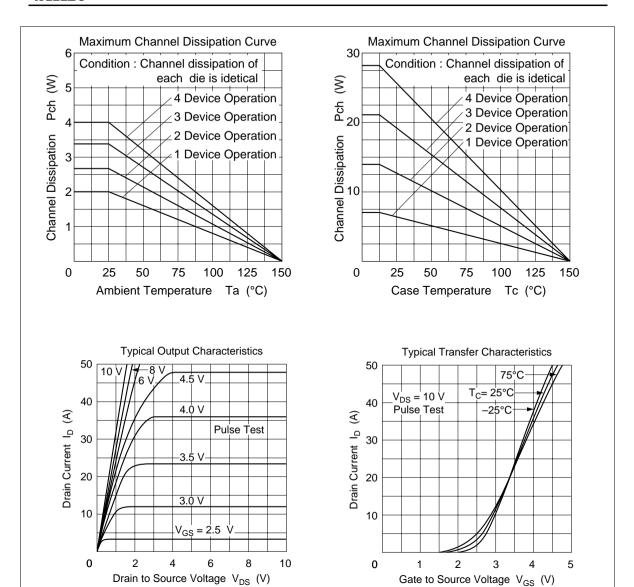
Notes: 1. PW \leq 10 μ s, duty cycle \leq 1%

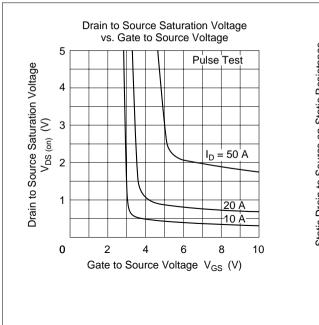
2. 4 Devices operation

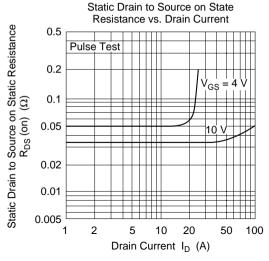
Electrical Characteristics ($Ta = 25^{\circ}C$)

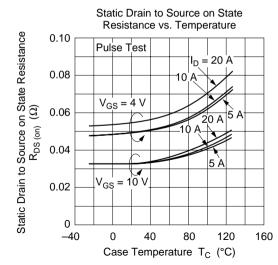
Item	Symbol	Min	Тур	Max	Unit	Test conditions
Drain to source breakdown voltage	$V_{(BR)DSS}$	60	_	_	V	$I_D = 10 \text{ mA}, V_{GS} = 0$
Gate to source breakdown voltage	$V_{(BR)GSS}$	±20	_	_	V	$I_G = \pm 100 \ \mu A, \ V_{DS} = 0$
Gate to source leak current	I _{GSS}	_	_	±10	μΑ	$V_{GS} = \pm 16 \text{ V}, V_{DS} = 0$
Zero gate voltage drain current	I _{DSS}	_	_	250	μΑ	$V_{DS} = 50 \text{ V}, V_{GS} = 0$
Gate to source cutoff voltage	$V_{\rm GS(off)}$	1.0	_	2.0	V	$I_{D} = 1 \text{ mA}, V_{DS} = 10 \text{ V}$
Static drain to source on state resistance	$R_{DS(on)}$	_	0.045	0.06	Ω	$I_D = 5 A$ $V_{GS} = 10 V^{*1}$
		_	0.056	0.075	Ω	$I_D = 5 A$ $V_{GS} = 4 V^{*1}$
Forward transfer admittance	$ y_{fs} $	10	12	_	S	$I_D = 5 A$ $V_{DS} = 10 V^{*1}$
Input capacitance	Ciss	_	1400		pF	$V_{DS} = 10 \text{ V}$
Output capacitance	Coss	_	720	_	pF	$V_{GS} = 0$
Reverse transfer capacitance	Crss	_	220	_	pF	f = 1 MHz
Turn-on delay time	$t_{\text{d(on)}}$	_	15		ns	$I_{D} = 10 \text{ A}$
Rise time	t _r	_	95	_	ns	V _{GS} = 10 V
Turn-off delay time	$t_{\text{d(off)}}$	_	300	_	ns	$R_L = 3 \Omega$
Fall time	t _f	_	170	_	ns	
Body to drain diode forward voltage	V_{DF}	_	1.05	_	V	$I_F = 10 \text{ A}, V_{GS} = 0$
Body to drain diode reverse recovery time	t _{rr}	_	110	_	μs	$I_F = 10 \text{ A}, V_{GS} = 0,$ $dIF/dt = 50 \text{ A}/\mu\text{s}$

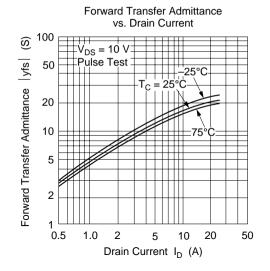
Note: 1. Pulse Test



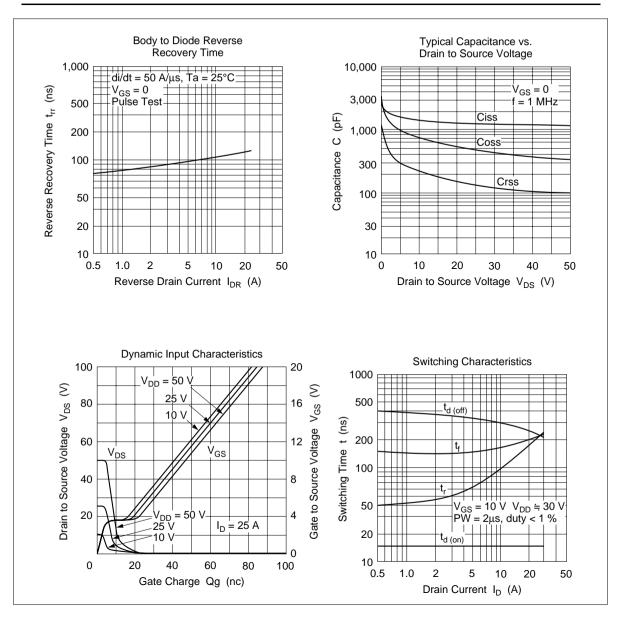


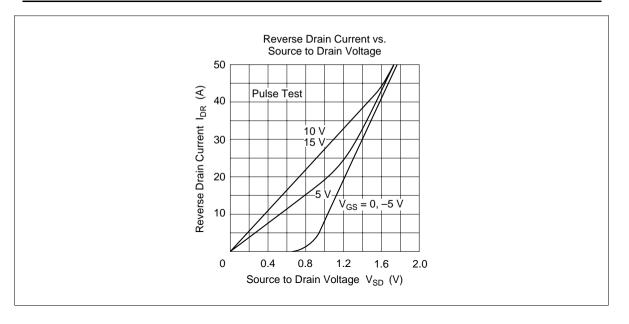




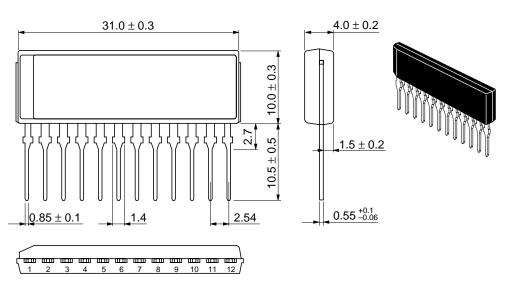


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Unit: mm



Hitachi Code	SP-12
JEDEC	_
EIAJ	
Weight (reference value)	3.6 g

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